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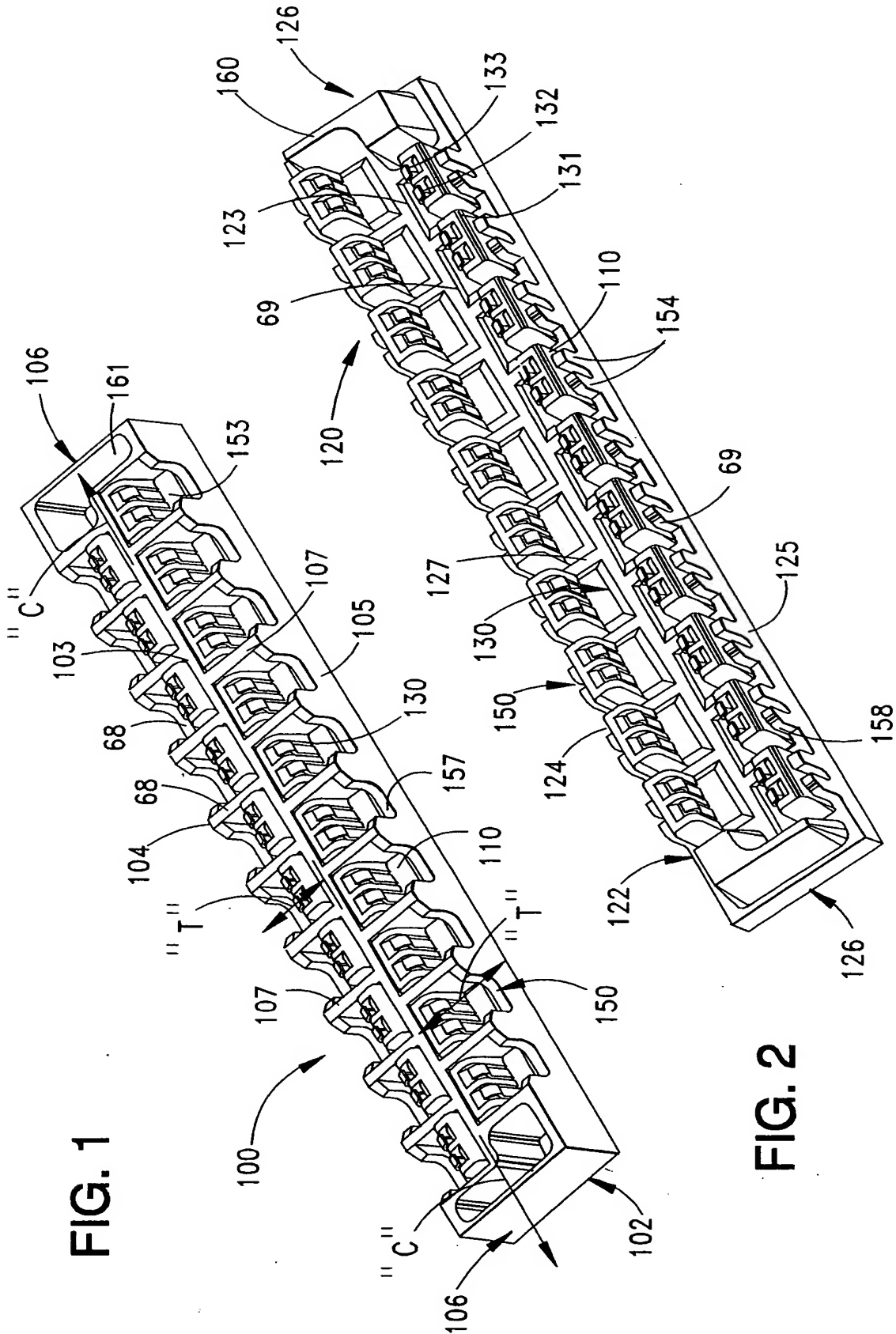
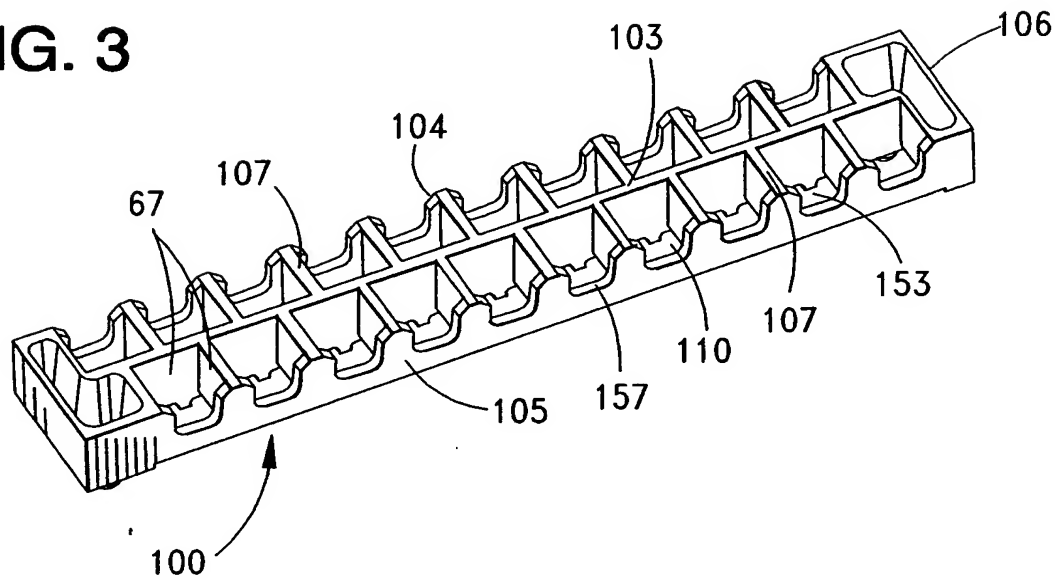


FIG. 1

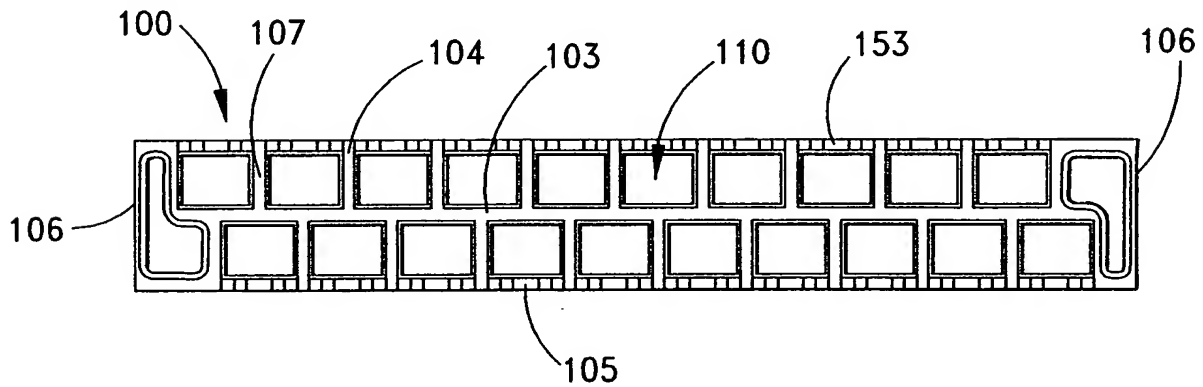
FIG. 2

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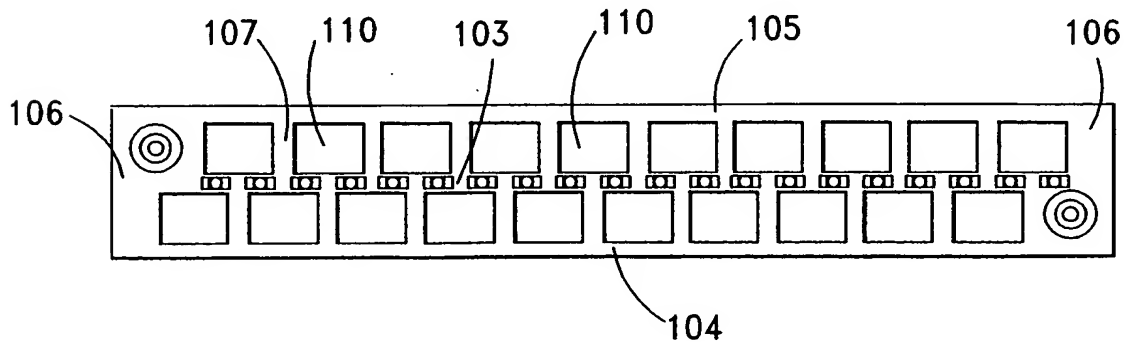
**FIG. 3**



**FIG. 4**



**FIG. 4**



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FIG. 6

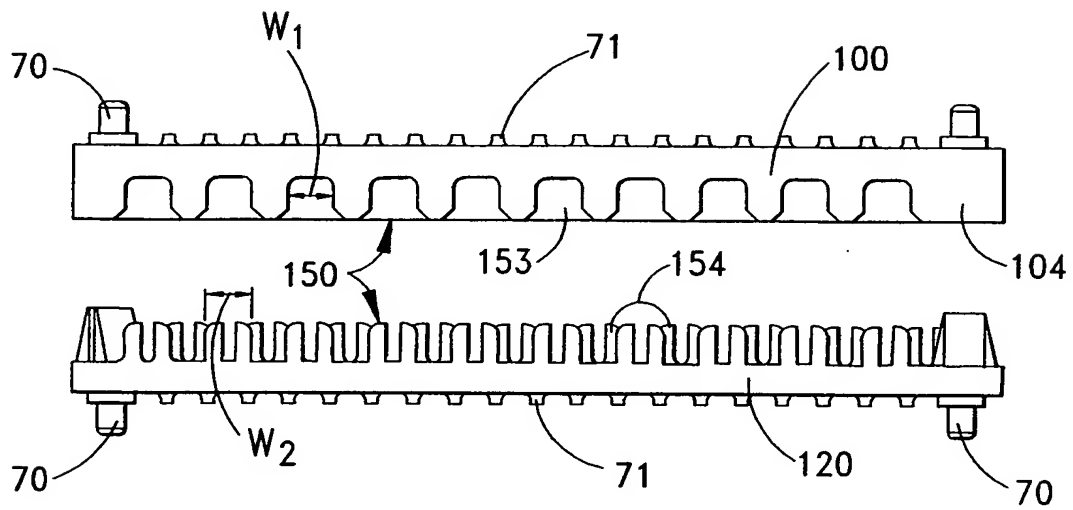


FIG. 7

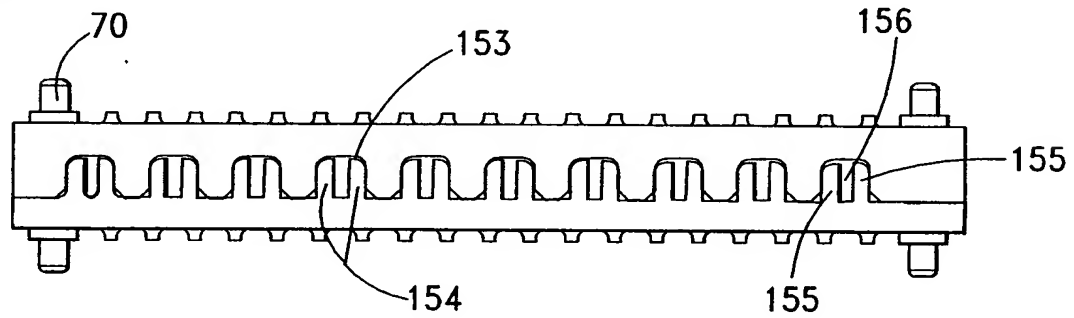


FIG. 8

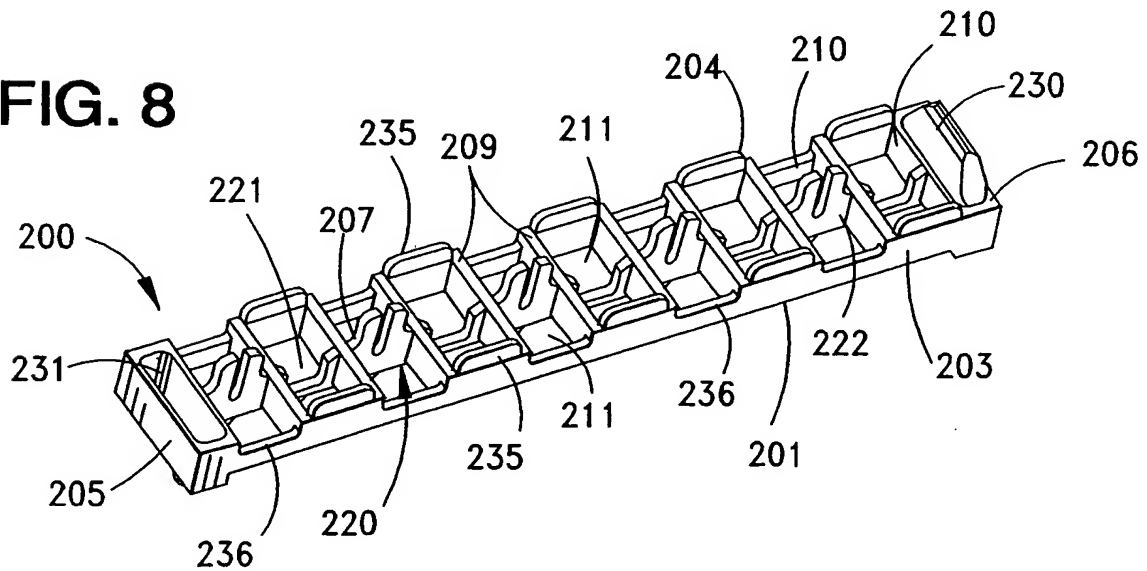


FIG. 1 is a perspective view of a multi-layer printed circuit board 10. The board has a central section 14 and end sections 13. It features a series of components 302, 311, and 320/321. A 'C' label is also present.

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FIG. 12

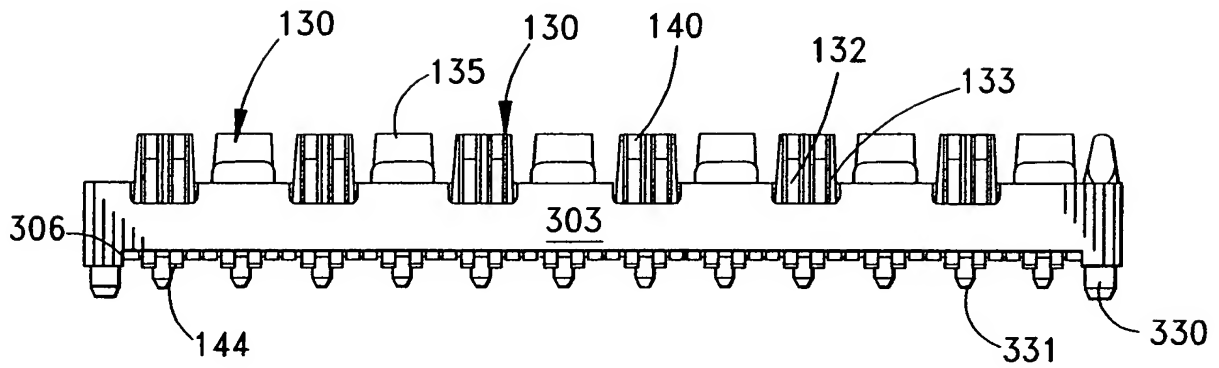


FIG. 13

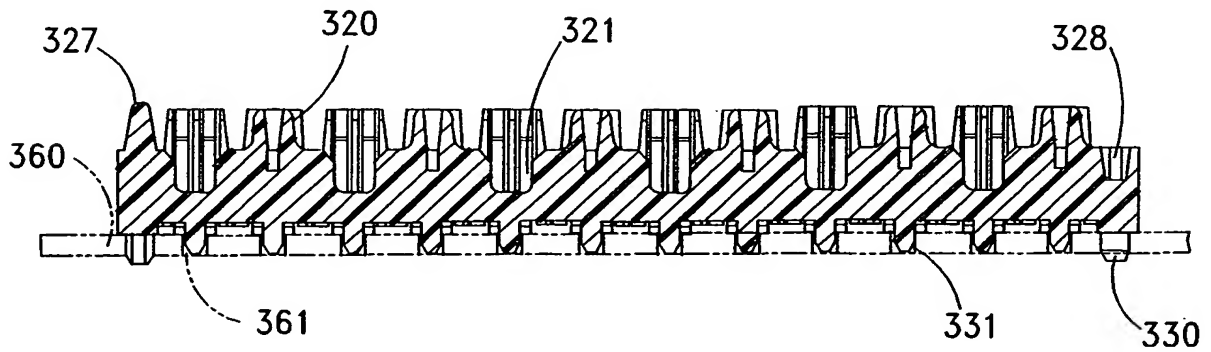
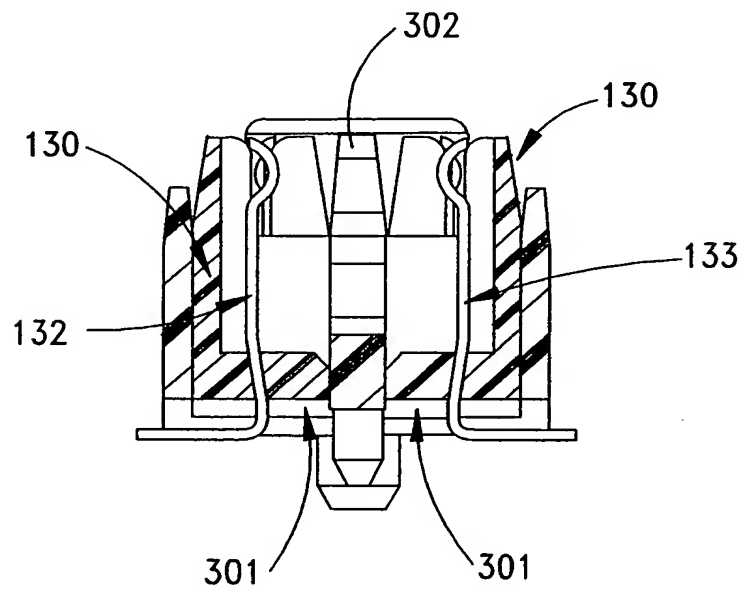


FIG. 14



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FIG. 15

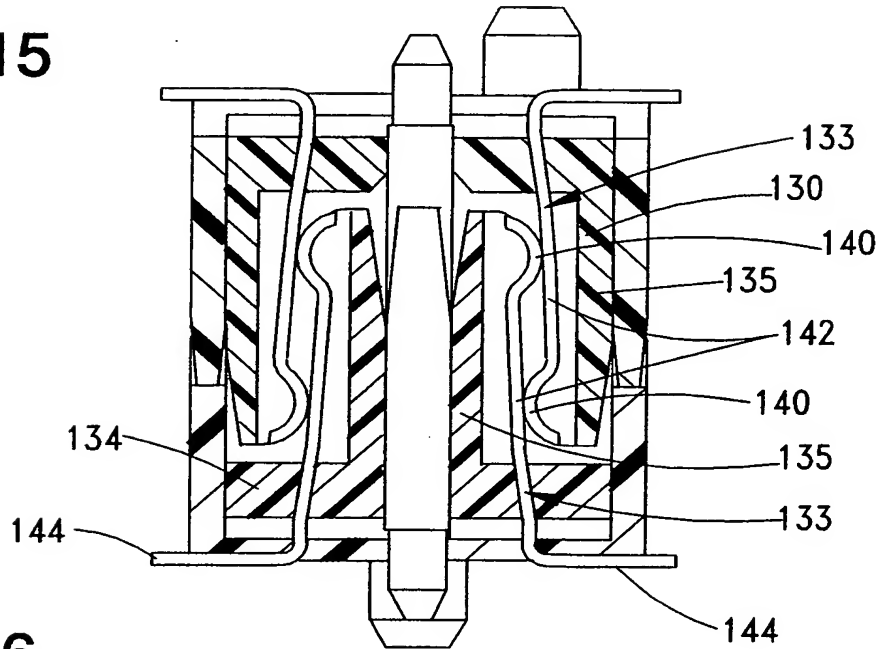


FIG. 16

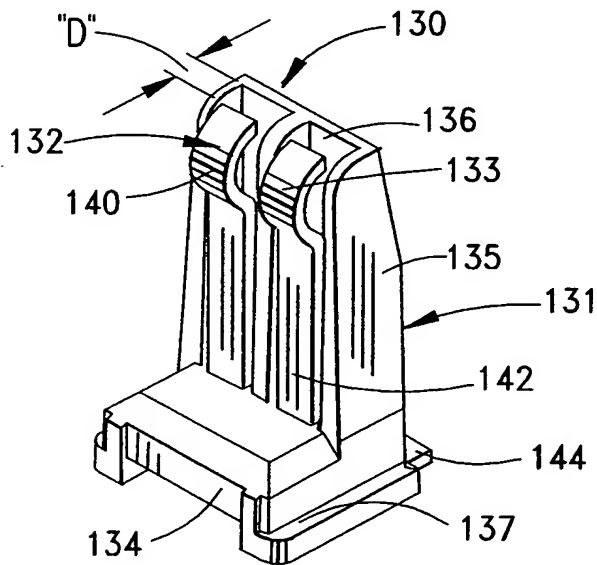


FIG. 17

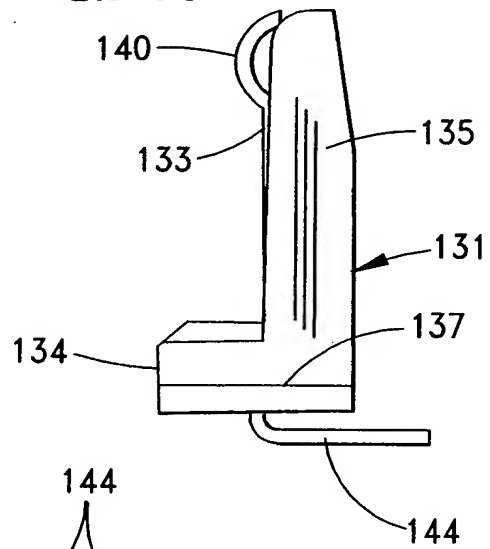
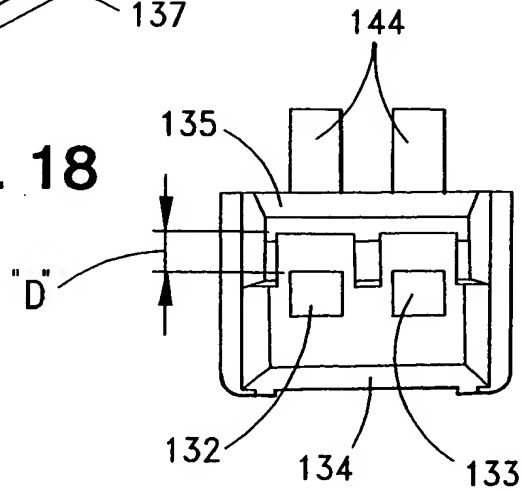
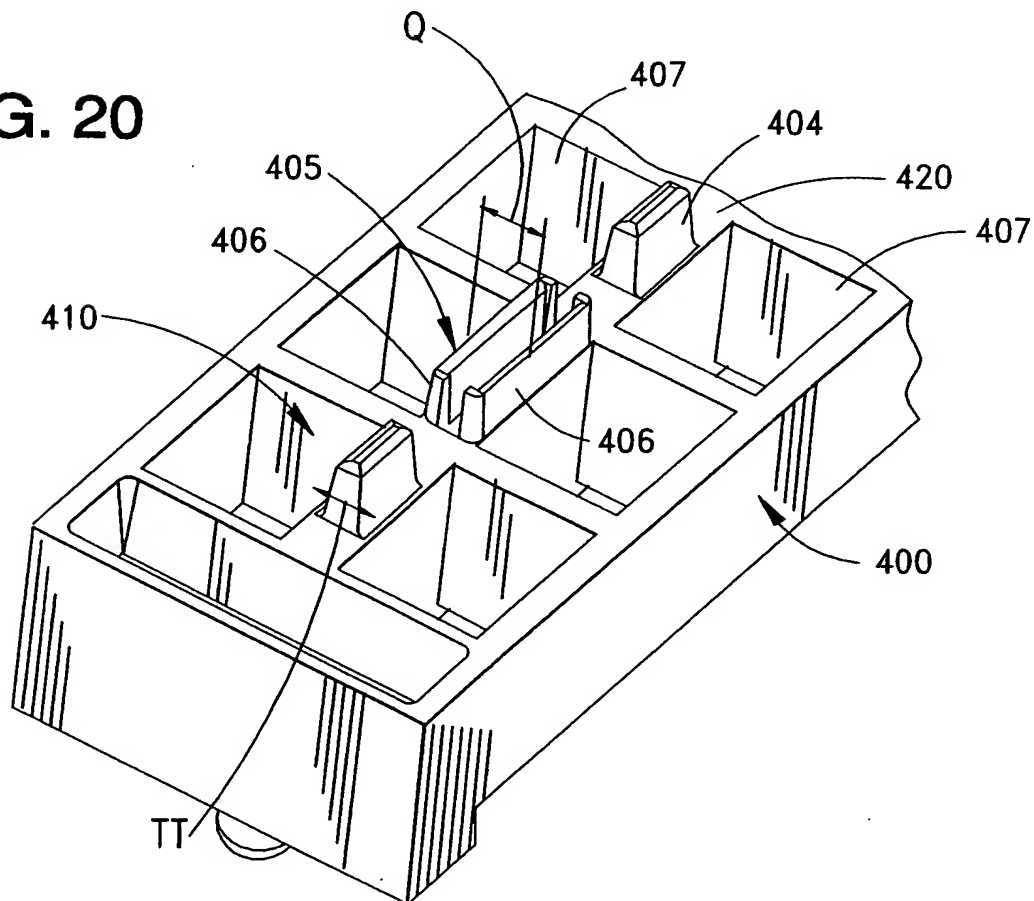


FIG. 18





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FIG. 21

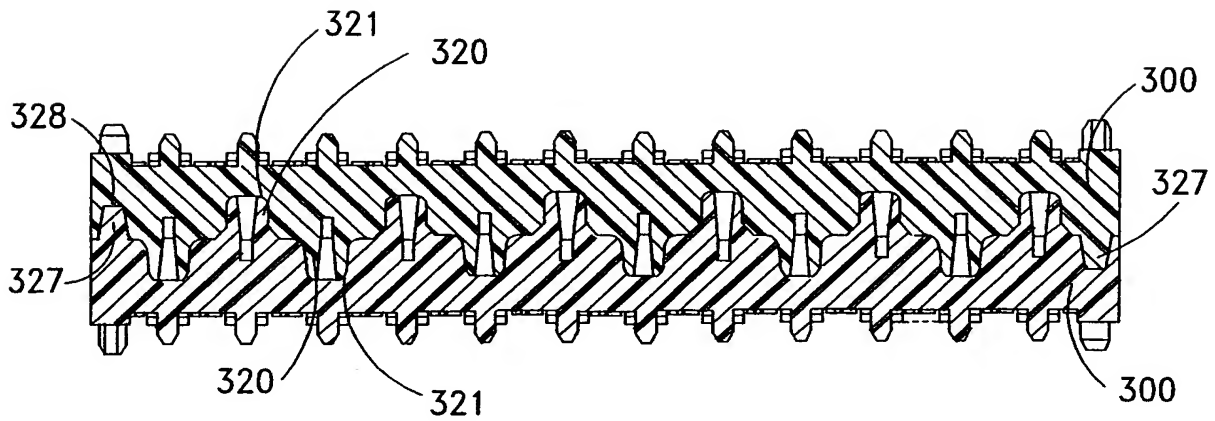
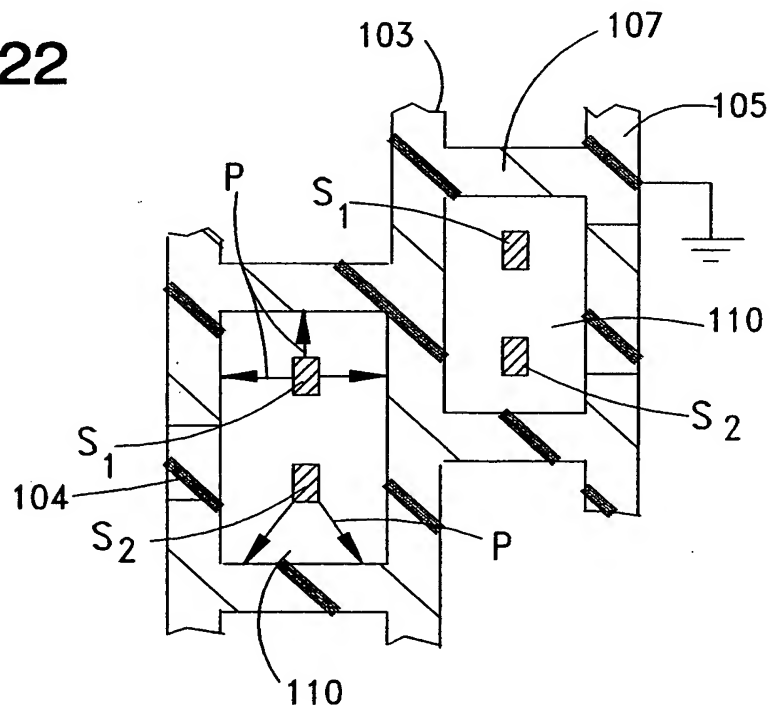


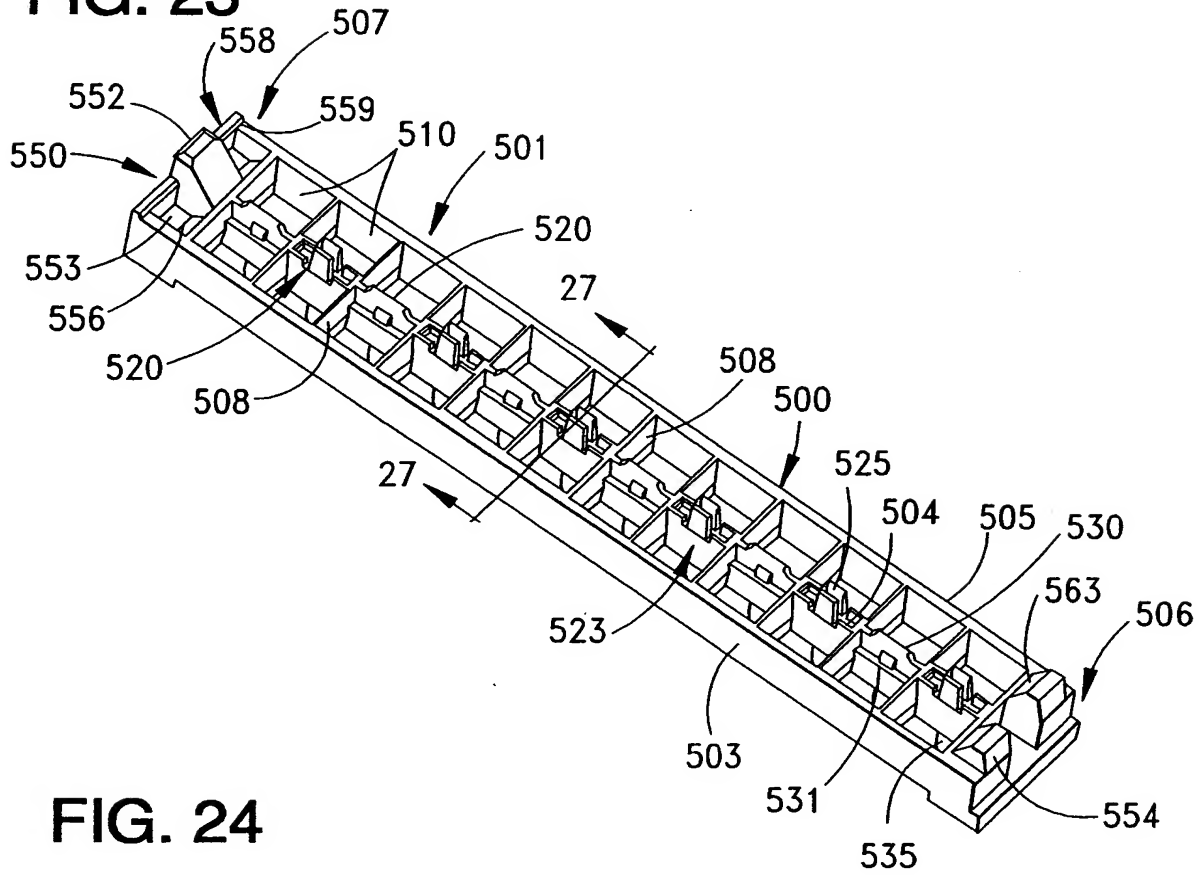
FIG. 22



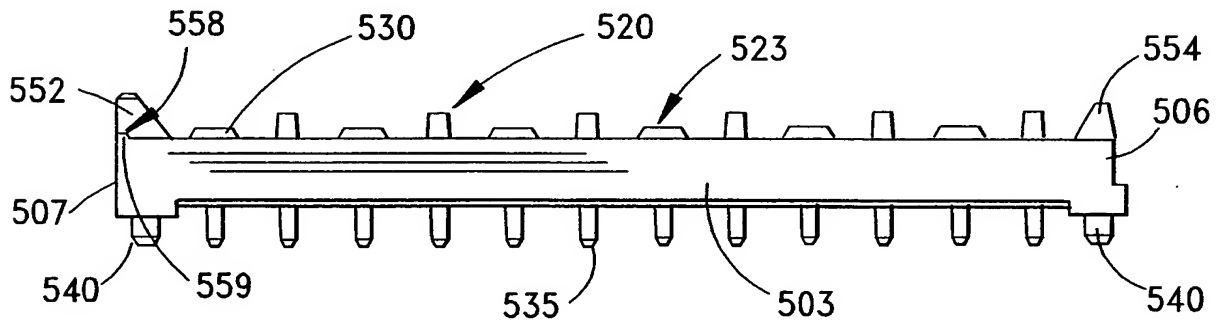


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**FIG. 23**



**FIG. 24**



**FIG. 25**

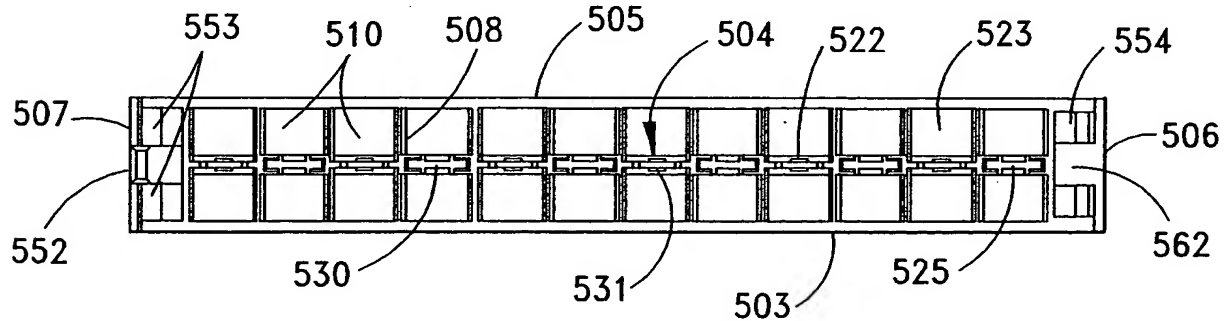


FIG. 26

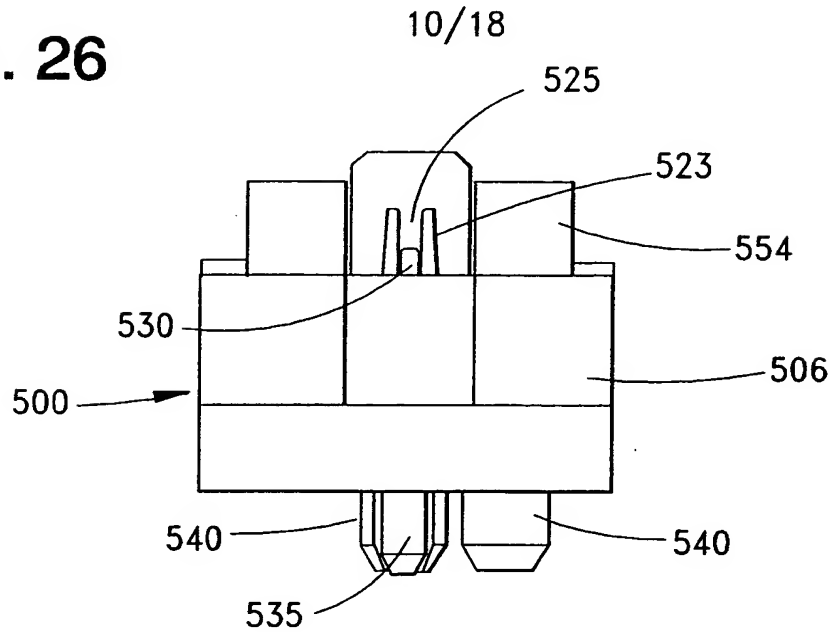


FIG. 27

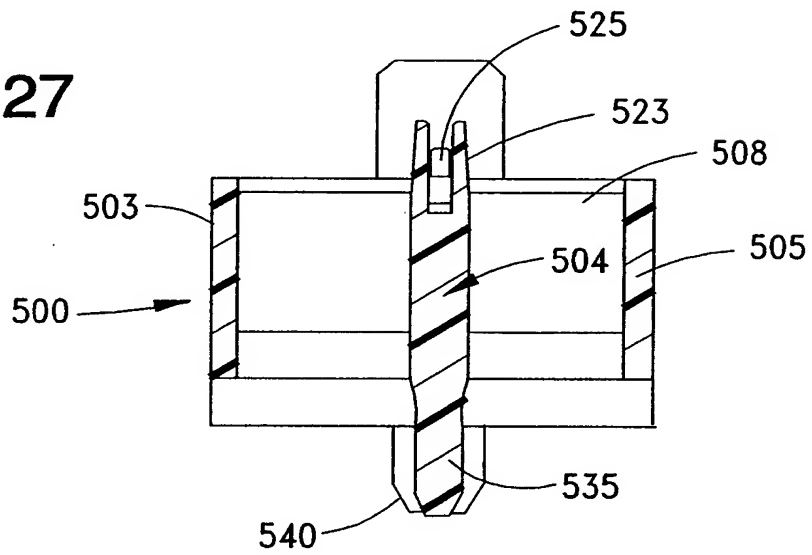


FIG. 28

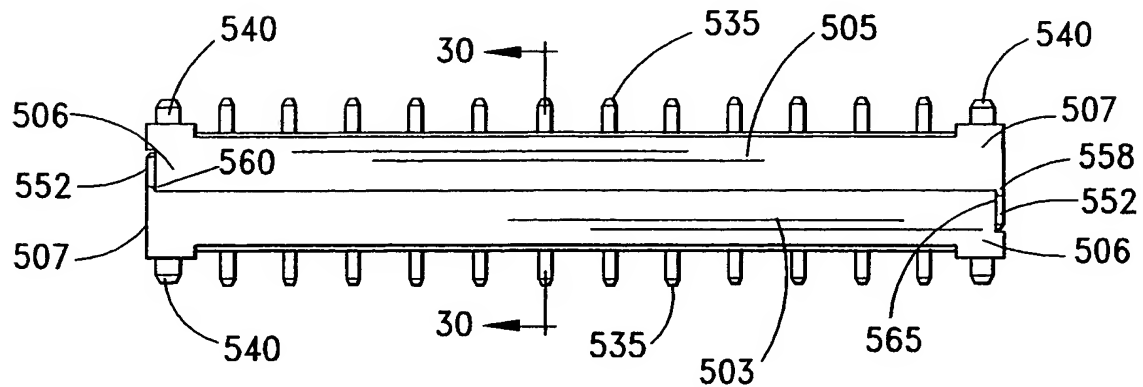


FIG. 29

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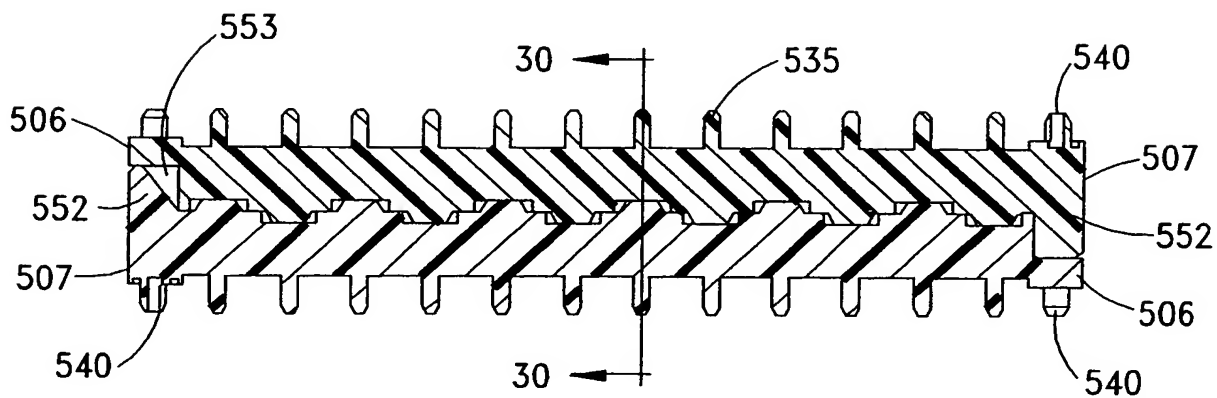


FIG. 30

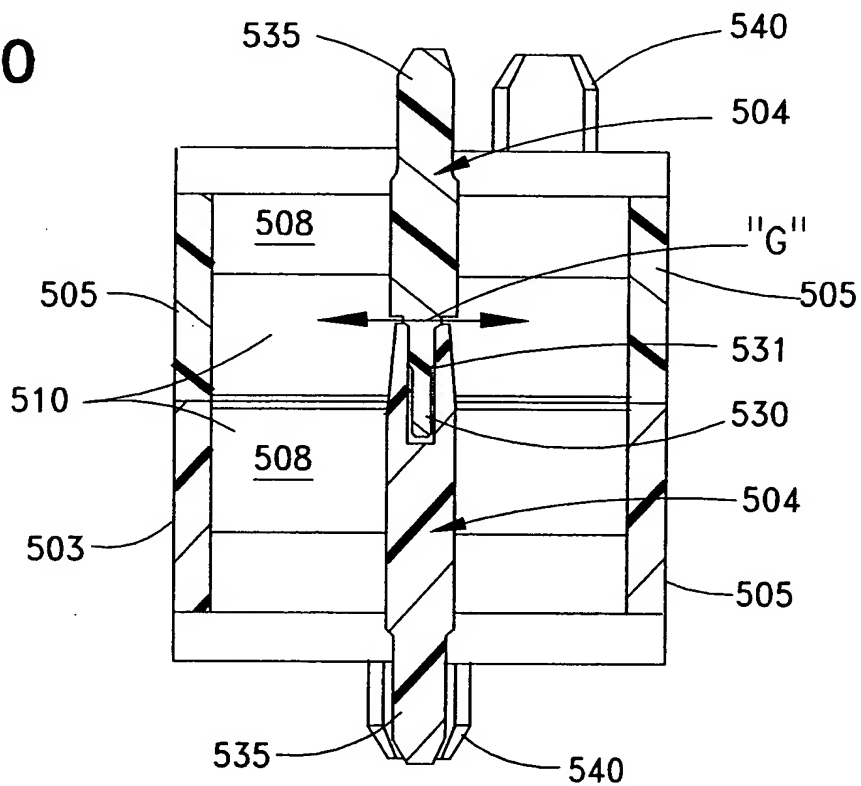


FIG. 31

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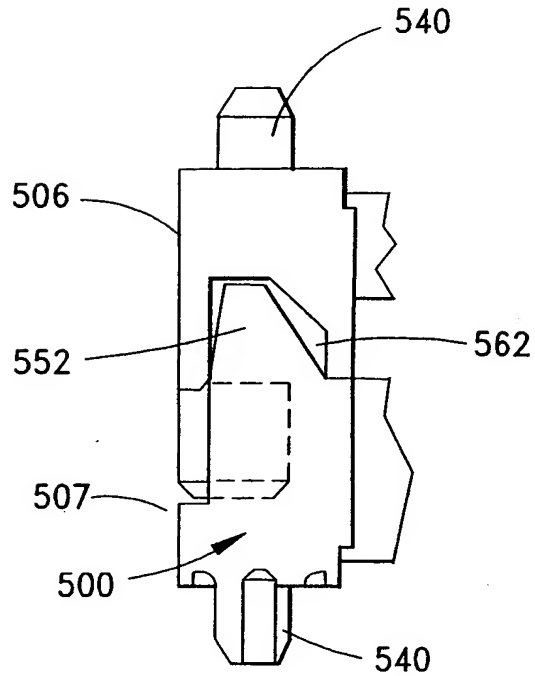


FIG. 32

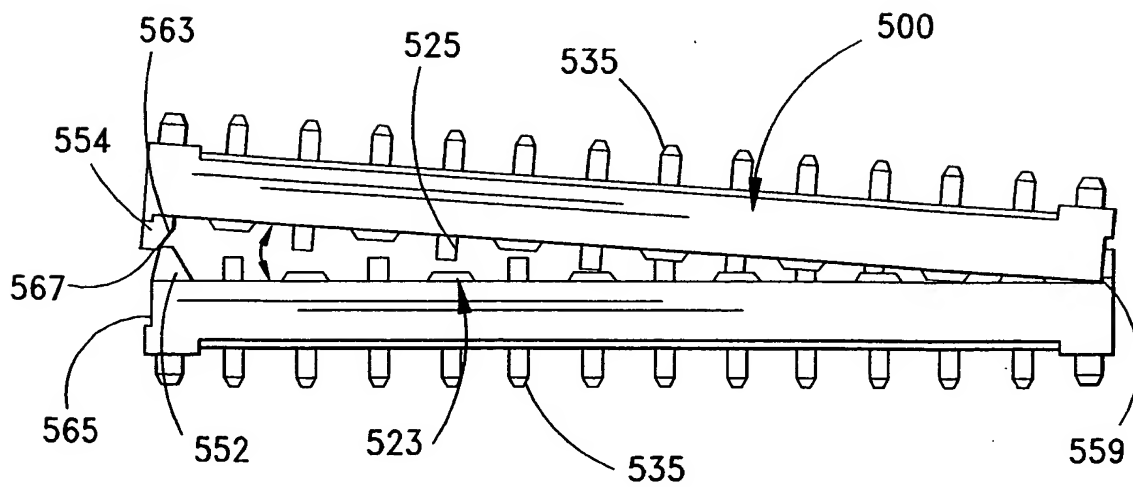


FIG. 33

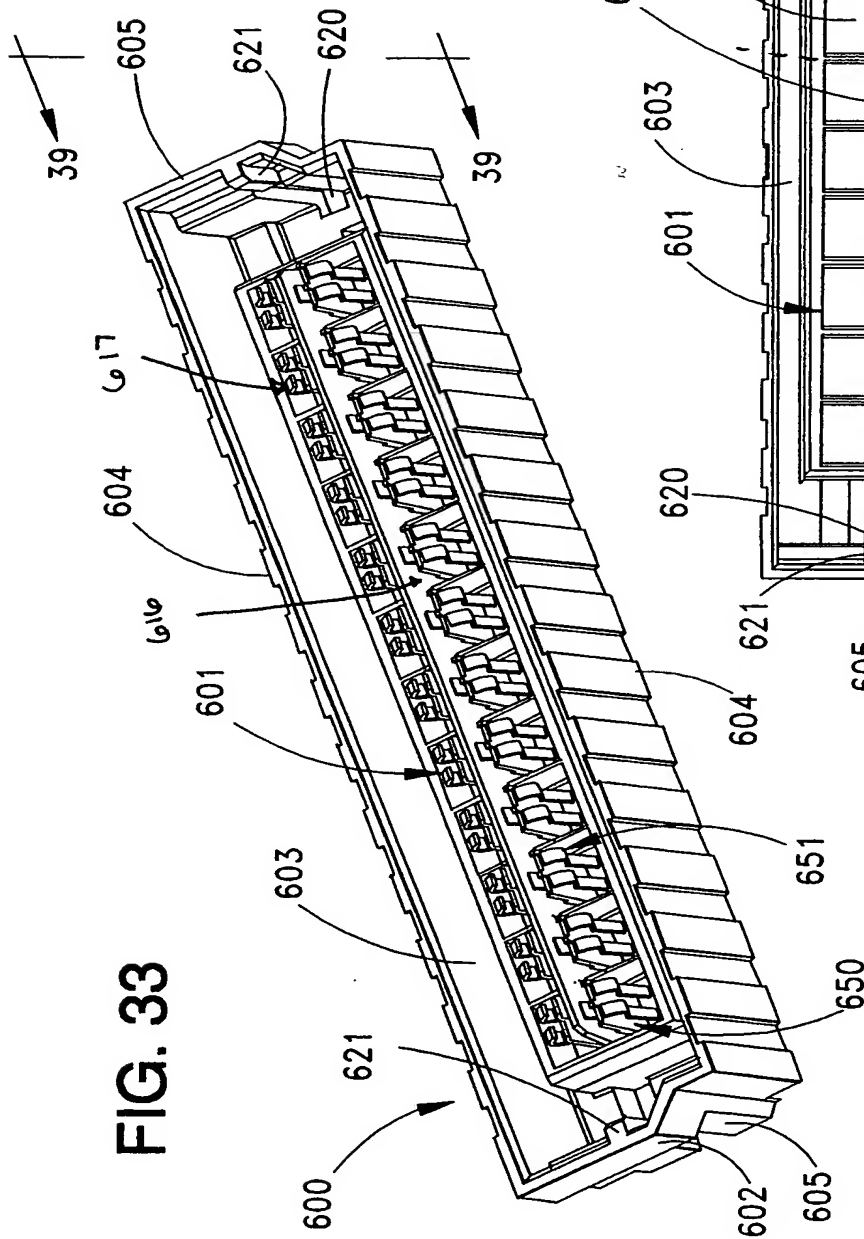
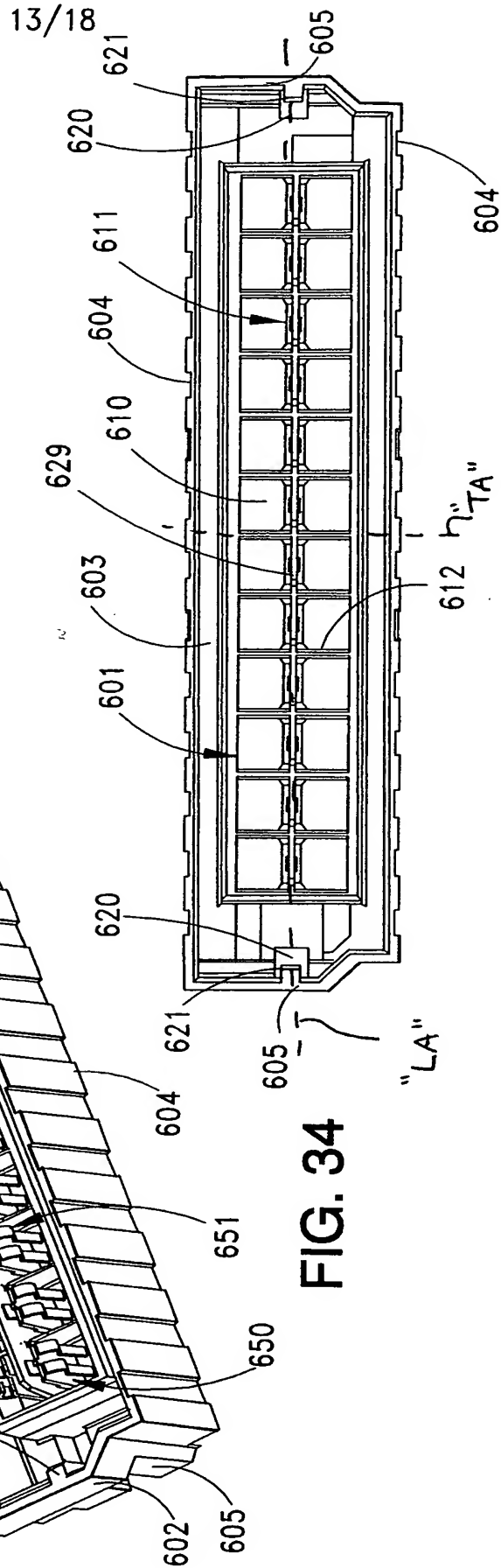


FIG. 34



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FIG. 35

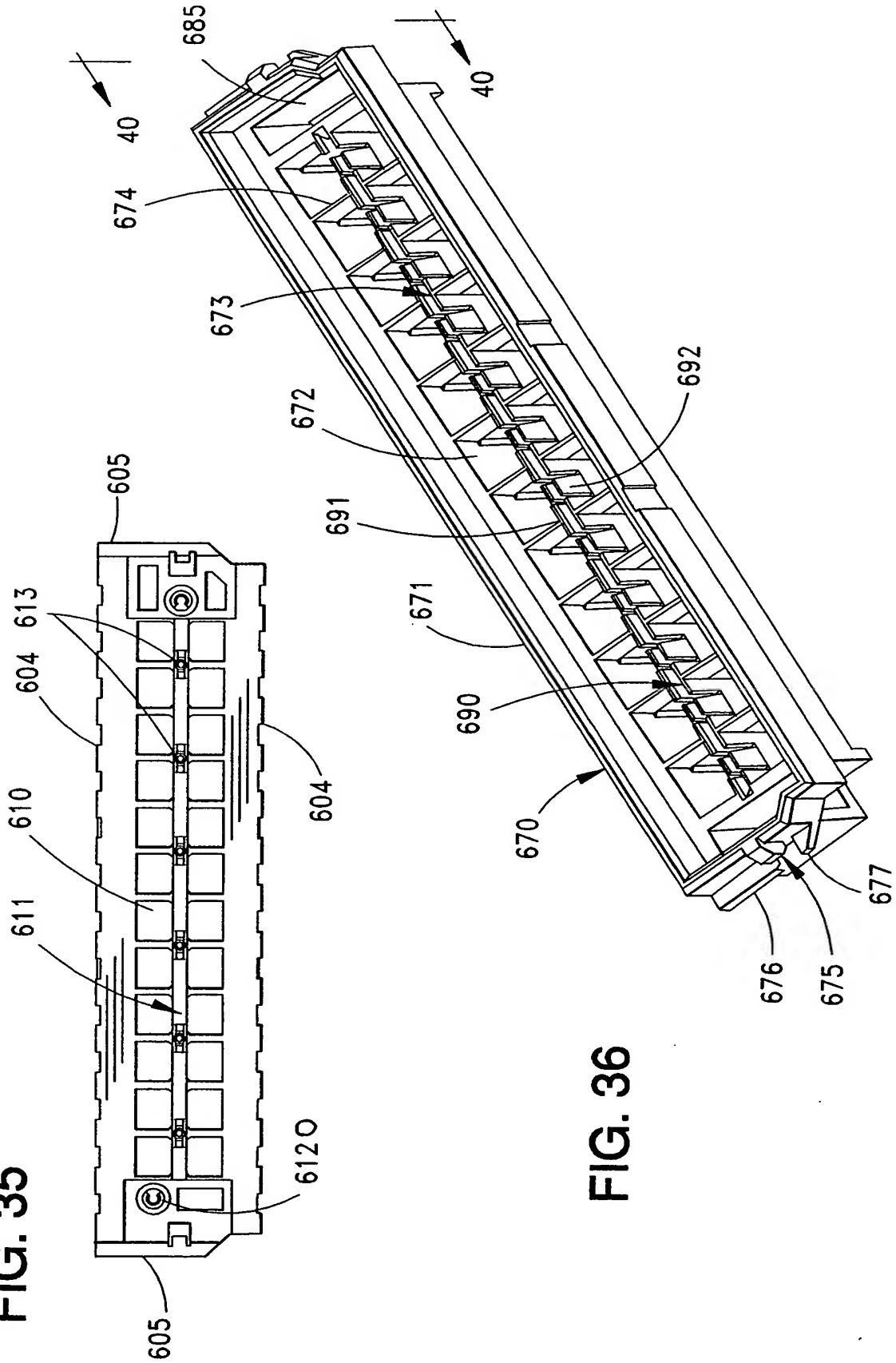
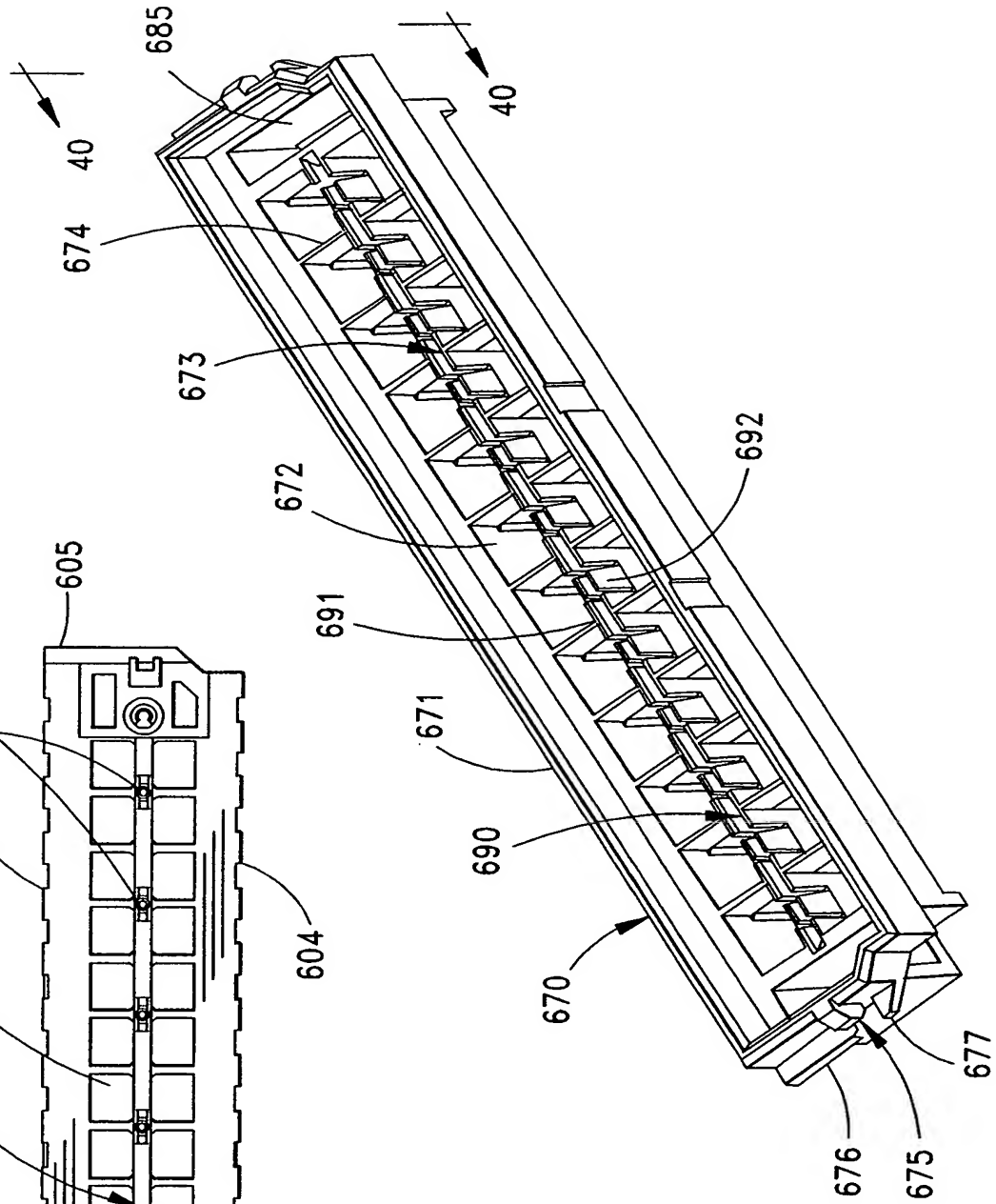


FIG. 36



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FIG. 37

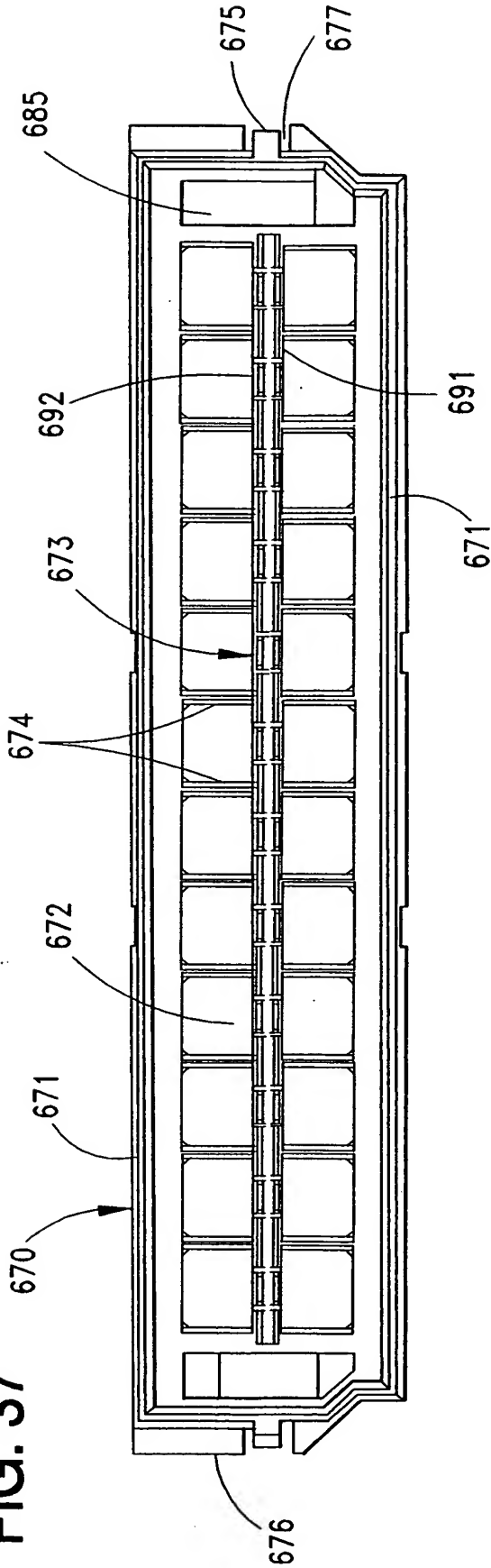
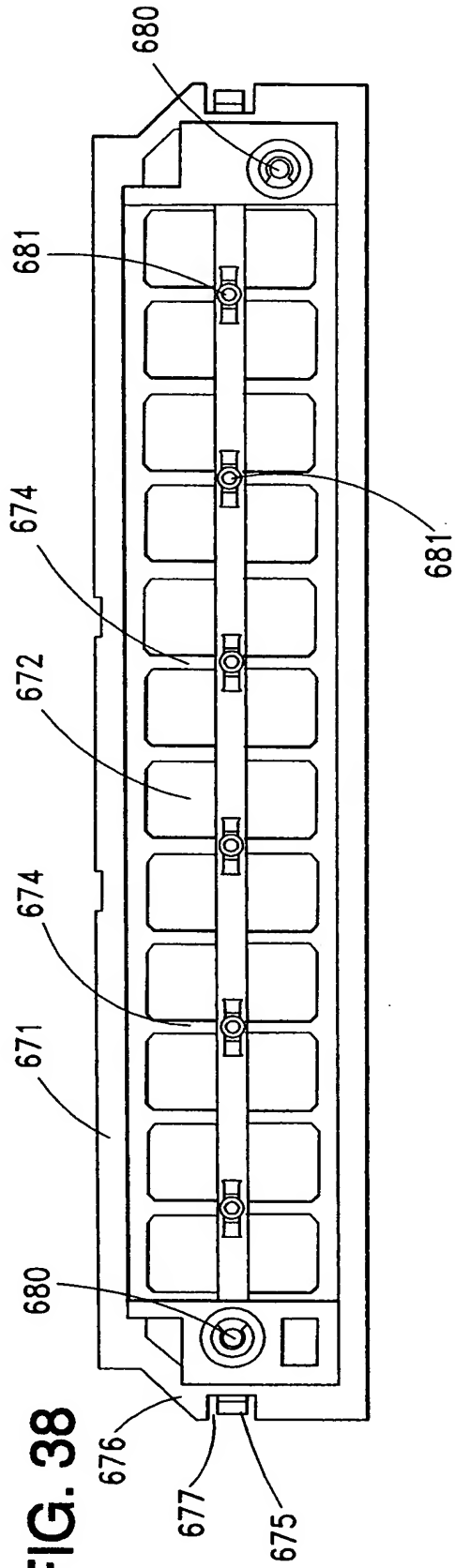


FIG. 38



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FIG. 42

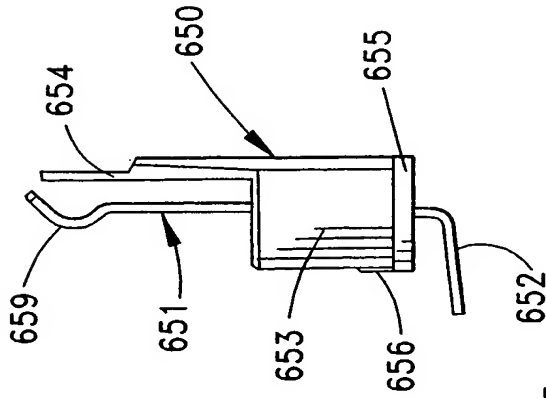


FIG. 41

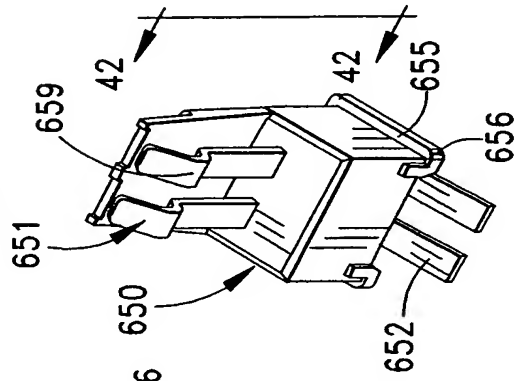


FIG. 40

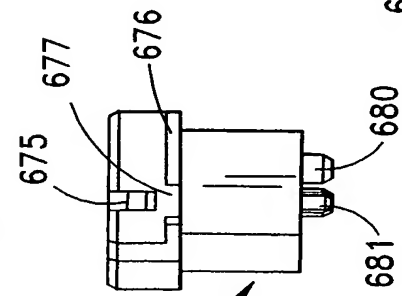


FIG. 39

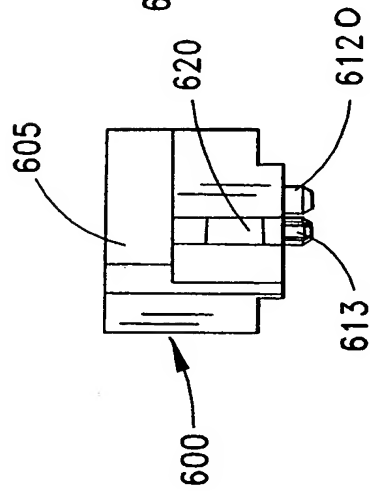
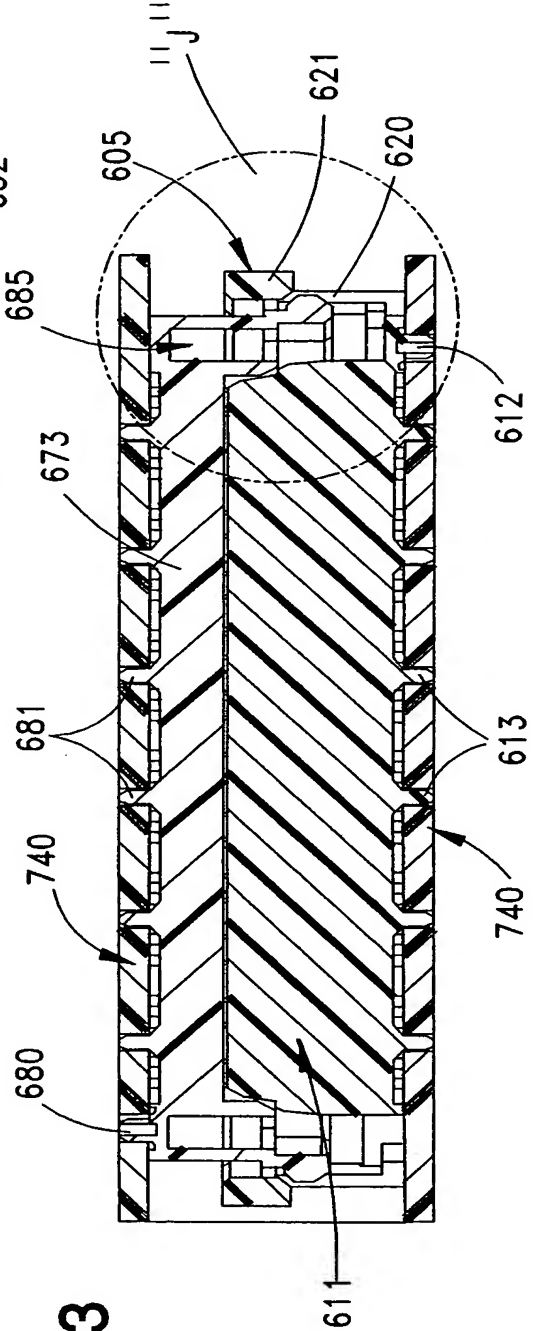


FIG. 43





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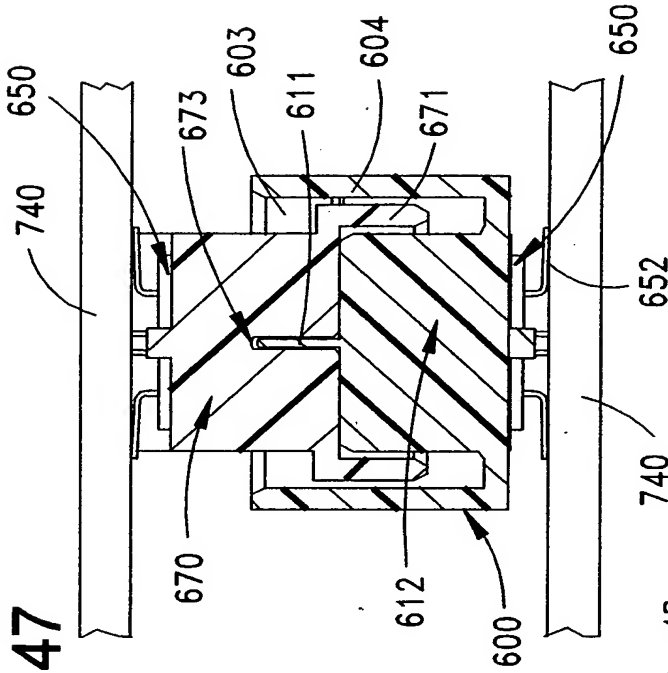


FIG. 47

FIG. 46

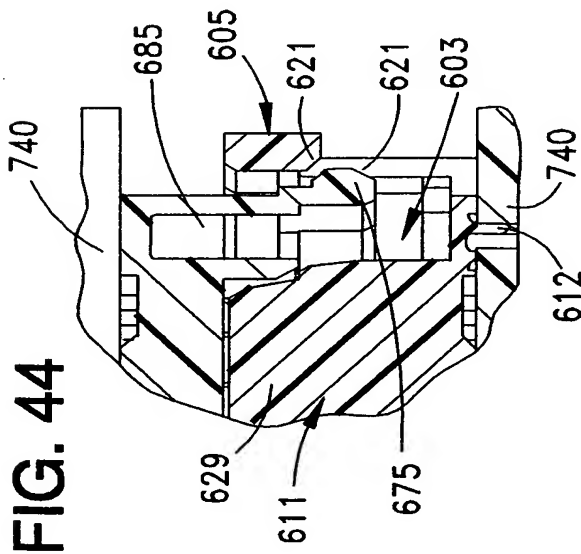
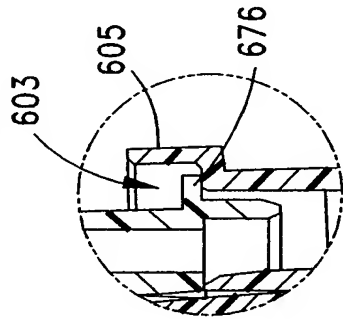


FIG. 44

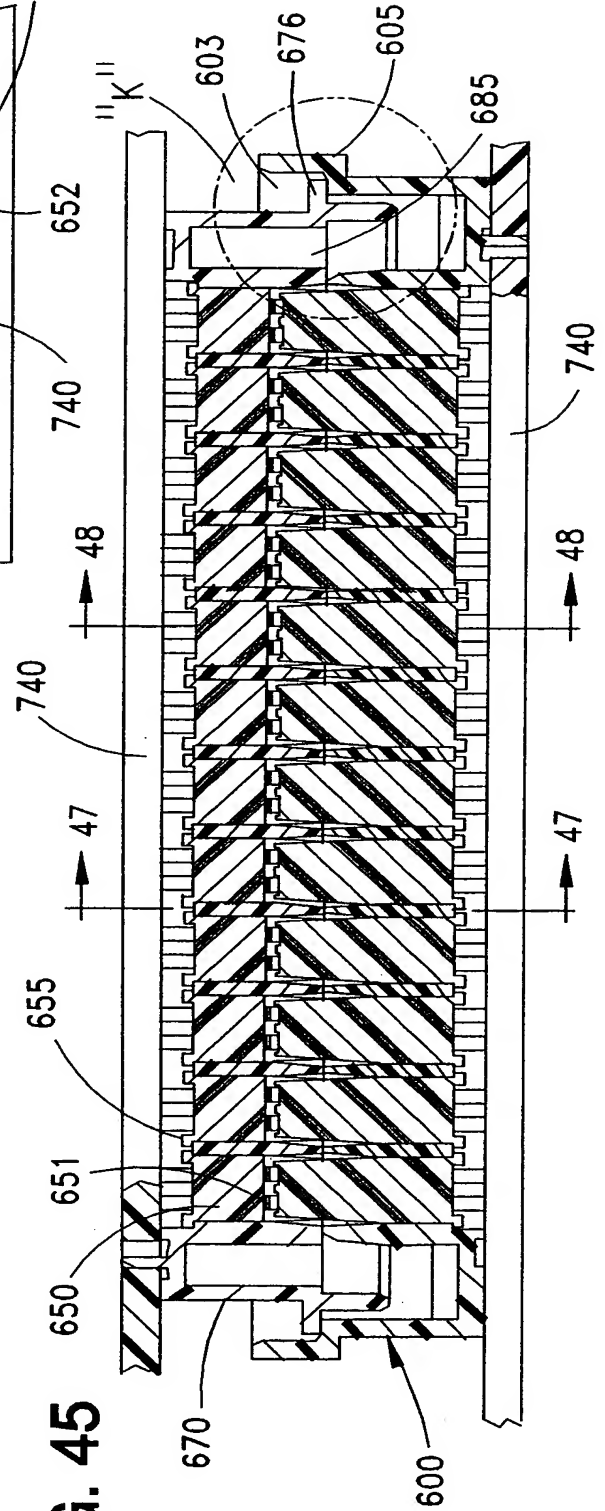


FIG. 45

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FIG. 48

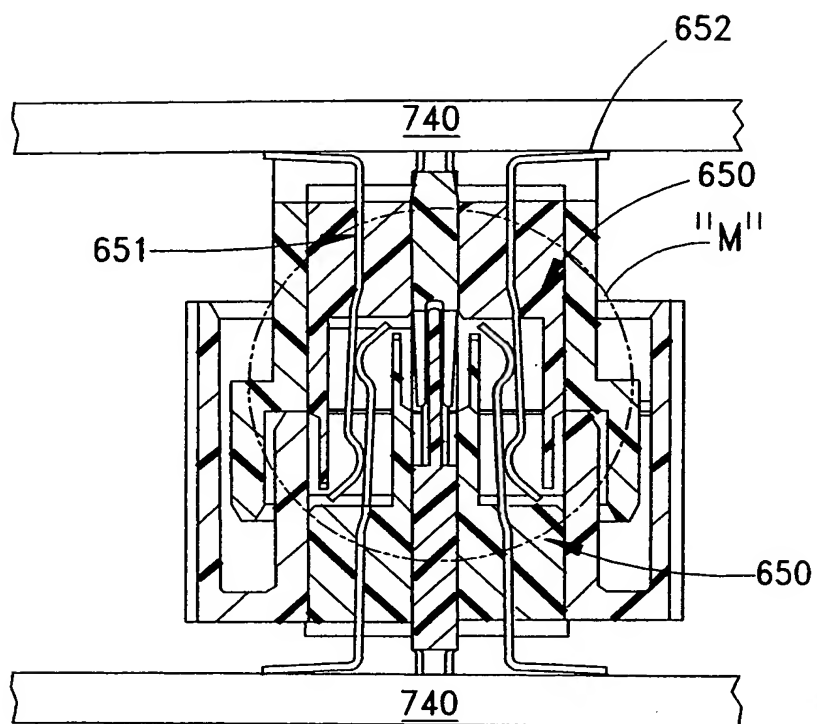


FIG. 49

